

Global Die Bonder Equipment Market Research Report 2012-2024

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Abstracts

SUMMARY

Die bonding is the process of attaching a die/chip to a substrate or package. Die bonding is accomplished by using one of the following processes: 1. Eutectic; 2. Solder; 3. Adhesive; 4. Glass or Silver-Glass

The global Die Bonder Equipment market will reach xxx Million USD in 2019 with CAGR xx% 2019-2024. The objective of report is to define, segment, and project the market on the basis of product type, application, and region, and to describe the content about the factors influencing market dynamics, policy, economic, technology and market entry etc.

Based on products type, the report describes major products type share of regional market. Products mentioned as follows:

Fully Automatic

Semi-Automatic

Manual

Leading vendors in the market are included based on profile, business performance etc. Vendors mentioned as follows:

Besi

ASM Pacific Technology (ASMPT)

Kulicke & Soffa

Palomar Technologies

Shinkawa

DIAS Automation

Toray Engineering

Panasonic

FASFORD TECHNOLOGY

West-Bond

Hybond

Based on Application, the report describes major application share of regional market. Application mentioned as follows:

Integrated Device Manufacturers (IDMs)

Outsourced Semiconductor Assembly and Test (OSAT)

Based on region, the report describes major regions market by products and application. Regions mentioned as follows:

Asia-Pacific

North America

Europe

South America

Middle East & Africa

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